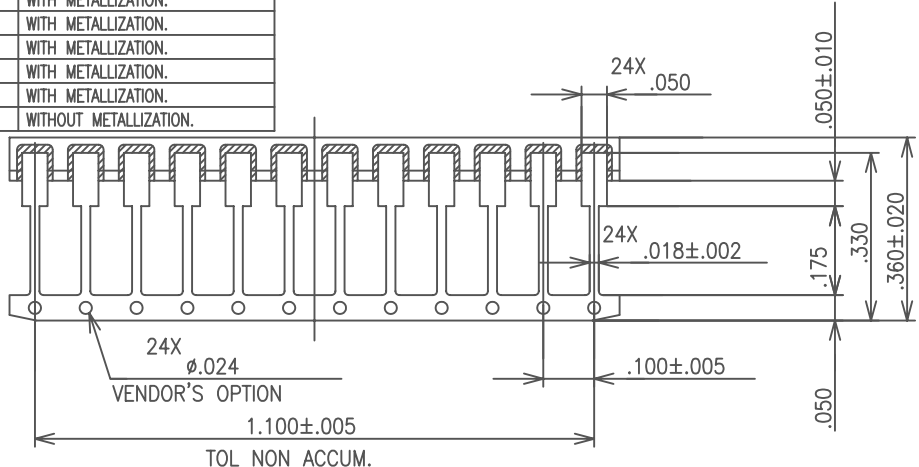


PART NO.	ID MARK	LEAD TIED DOWN	NOTCH AREA METALLIZED
01		NIL	WITH METALLIZATION.
02		NO.12 ONLY	WITH METALLIZATION.
03		NO.1 ONLY	WITH METALLIZATION.
04		NO.21 ONLY	WITH METALLIZATION.
05		NO.24 ONLY	WITH METALLIZATION.
06		NIL	WITHOUT METALLIZATION.



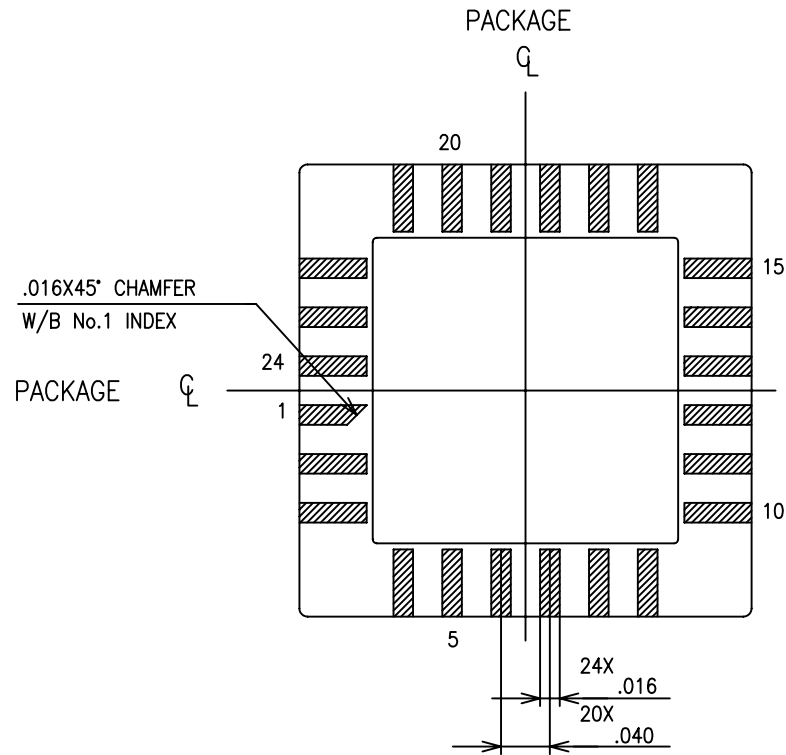
- NOTES :
1. PLATING THICKNESS TO BE PER CUSTOMER'S SPECIFICATION.
 2. SEAL AREA TO BE METALLIZED.
 3. DIE ATTACH AREA TO BE METALLIZED.
 4. LEAD RESISTANCE : 0.30 OHM MAX.
 5. WIRE BOND PAD CONNECTED TO CORRESPONDED OUTER LEADS.
- DIE ATTACH CONNECTION TO BE DEFINED BY TABLE.

SW024I299-5	S=0 D=24	SB024I299-5	S=0 D=24
SW024I299-4	S=0 D=21	SB024I299-4	S=0 D=21
SW024I299-3	S=0 D=1	SB024I299-3	S=0 D=1
SW024I299-2	S=0 D=12	SB024I299-2	S=0 D=12
SW024I299-1	S=0 D=0	SB024I299-1	S=0 D=0

MODIFICATION	DESCRIPTION	DATE	DRAWN	CHECKED	APPROVED	NAME	TOLERANCE UNLESS OTHERWISE SPECIFIED	DRAWN	CHECKED	APPROVED	DATE
								S.F	S.T/TA	M.K	DEC.09.'91
	REDRAWN	FEB.16.'07	Y.H/YA	TO.H/MSU	H.SA	24 LEAD SIDE BRAZED PACKAGE	±.005				
	DELETED:GRINDING AFTER Au PLATING	SEP.16.'93	Y.M	H.S/S.F	T.A	SCALE 4 / 1	THIRD ANGLE PROJECTION				
	REDRAWN (CAD DATA)	DEC.09.'91	M.S	S.T/TA	M.K	MATERIAL AS INDICATED					
	CHANGED	DATE	DRAWN	CHECKED	APPROVED						
						KYOCERA CORPORATION KYOTO JAPAN					
								DRAWING NO. KD-S78299-J			SHEET 1 / 2



SSM P/N: CSB02488



BONDING PATTERN

MODIFICATION						NAME 24 LEAD SIDE BRAZED PACKAGE	TOLERANCE UNLESS OTHERWISE SPECIFIED	DRAWN S.F	CHECKED S.T/TA	APPROVED M.K	DATE DEC.09.91
						SCALE 10 / 1	MATERIAL				
	△	REDRAWN	FEB.16.07	Y.H/YA	TO.H/MSU	H.SA					
		CHANGED	DATE	DRAWN	CHECKED	APPROVED	KYOCERA CORPORATION KYOTO JAPAN	THIRD ANGLE PROJECTION	DRAWING NO. KD-S78299-J		SHEET 2 / 2



